Thermal Design of NVSU119C (U385) LEDs

1. Objective
The LEDs’ light output can be affected by the heat generated from the LEDs/LED-assembled products. Also, the reliability performance can be seriously degraded, if the LEDs are operated over the absolute maximum rated junction temperature (Tj).

It is critical to design the heat dissipation performance not to exceed the Tjmax for NVSU119C, to deliver high reliability/performance. This document shows the Tj evaluation results by demonstrating two heat dissipation conditions. Please use the data for reference to your thermal design.

2. Tj Calculation
Tj can be calculated by the following formula:

\[
T_j = T_s + R_{thj-s} \times P_D
\]

3. Ts Measuring Point

4. Tj Evaluation Result

Example 1. Copper Board + Heat Sink A

<table>
<thead>
<tr>
<th>I_F (A)</th>
<th>T_s (°C)</th>
<th>V_F (V)</th>
<th>T_j (°C)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.7</td>
<td>39.0</td>
<td>3.3</td>
<td>46</td>
</tr>
<tr>
<td>1.4</td>
<td>52.1</td>
<td>3.4</td>
<td>67</td>
</tr>
</tbody>
</table>

Example 2. Copper Board + Heat Sink B

<table>
<thead>
<tr>
<th>I_F (A)</th>
<th>T_s (°C)</th>
<th>V_F (V)</th>
<th>T_j (°C)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.7</td>
<td>36.3</td>
<td>3.3</td>
<td>44</td>
</tr>
<tr>
<td>1.4</td>
<td>47.9</td>
<td>3.4</td>
<td>63</td>
</tr>
</tbody>
</table>

This sheet contains tentative information; we may change the contents without notice.

Dec. 5, 2017
5. Heat Dissipating Materials

Metal-based Board: Copper, 30mm × 30mm × 1.7mm
Heat Sink B: 50mm × 38mm × 25mm (H), Base Thickness: 5 mm, Fin: 8 pcs. (1mm × 38mm, Array: 1 × 8)
Heat Sink C: 54mm × 54mm × 35mm (H), Base Thickness: 4mm, Fin=64 pcs. (0.8mm × 9mm, Array: 5 × 13)

Note
We specified the absolute maximum ratings for NVSU119C(U385); IF= 1.4A and T_{jmax} = 125°C.
We cannot guarantee the usage over these ratings.
We appreciate your understanding and cooperation.